

NPN complex transistor with schottky barrier diode

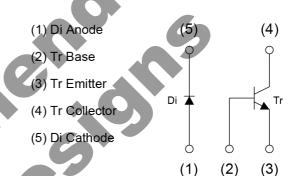
Parameter	Value
V _{CEO}	12V
IC	500mA

Outline SOT-353 SC-88A UMT5

Features

1)The 2SC5585 and a diode are housed independently in a SOT-353 package.

•Inner circuit



Application

General purpose small signal amplifier

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UML6N	SOT-353 (UMT5)	2021	TR	180	8	3000	L6

● Absolute maximum ratings (T_a = 25°C)

Pin No.1-5 Diode

Parameter	Symbol	Value	Unit
Average rectified forward current	Io	200	mA
Forward current surge peak (60Hz, 1cyc)	I _{FSM}	1	A
Reverse voltage	V _R	30	V
Junction temperature	T _j	125	°C

Pin No.2-3-4 Transistor

Parameter	Symbol	Value	Unit
Collector-base voltage	V_{CBO}	15	V
Collector-emitter voltage	V _{CEO}	12	V
Emitter-base voltage	V _{EBO}	6	V
Callector current	Ic	500	mA
Collector current	I _{CP}	1.0	А
Junction temperature	Tj	150	°C

Each element

Parameter	Symbol	Value	Unit
Power dissipation	P _D *1,*2	150	mW/Total
Range of storage temperature	T _{stg}	-55 ~ +125	°C



● Electrical characteristics (T_a = 25°C)

Pin No.1-5 Diode

Davanatas	Company of	Canditiana		Values		Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	
Forward voltage	V_R	I _F = 200mA	-	0.40	0.50	V
Reverse current	I _R	V _R = 10V	-	4.0	30	μA

Pin No.2-3-4 Transistor

Danamatan	0				Unit	
Parameter	Symbol			Тур.	Max.	Offic
Collector-base breakdown voltage	BV _{CBO}	Ι _C = 10μΑ	15	5	1	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	12	-	ı	٧
Emitter-base breakdown voltage	BV _{EBO}	I _E = 10μA	6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 15V	1	-	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 6V	-	-	100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 200mA, I _B = 10mA	-	90	250	mV
DC current gain	h _{FE}	$V_{CE} = 2V, I_{C} = 10 \text{mA}$	270	-	680	-
Transition frequency	f⊤	$V_{CE} = 2V, I_{E} = -10mA,$ f = 100MHz	-	320	1	MHz
Output capacitance	C_{ob}	V _{CB} = 10V, I _E = 0A, f = 1MHz	-	7.5	-	pF

^{*1} Each termunal mounted on a reference land.

^{*2 120}mW per element must not be exceeded.

● Electrical characteristic curves(Ta=25°C) < For Diode>

Fig.1 Reverse Current vs.
Reverse Voltage

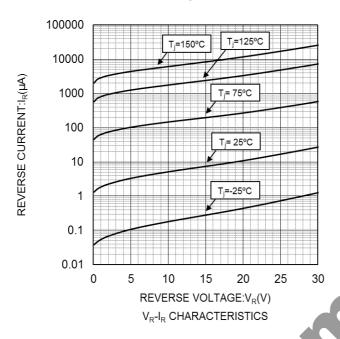


Fig.2 Forward Current vs. Forward Voltage

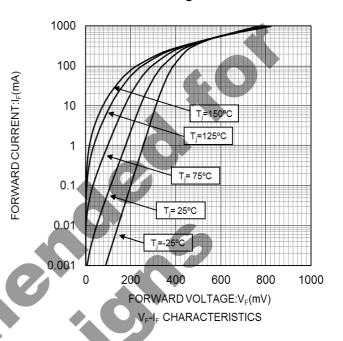
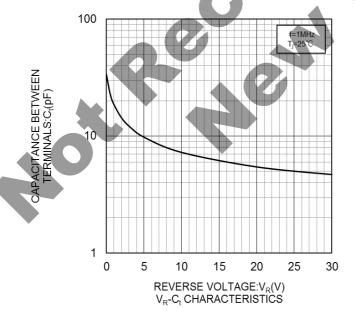
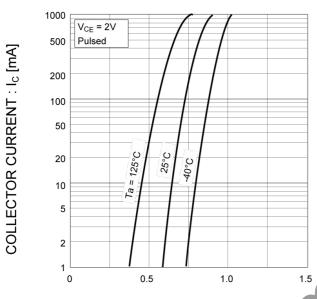


Fig.3 Capacitance Between Terminals vs. Reverse Voltage



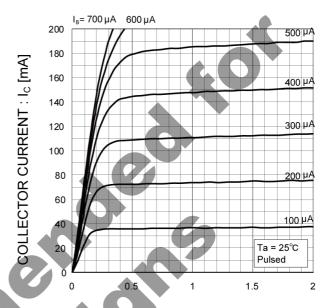
● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.4 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE : VBE. [V]

Fig.5 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE : $V_{CE}\left[V\right]$

Fig.6 DC Current Gain vs. Collector Current (I)

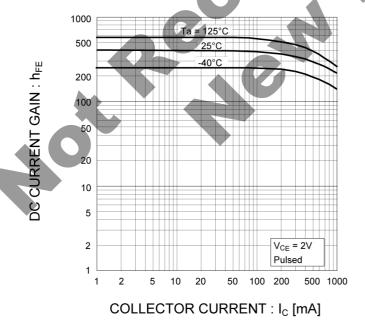
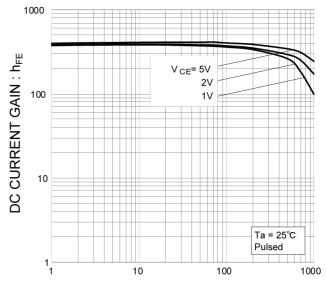


Fig.7 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves(T_a=25°C) < For Transistor>

Fig.8 Collector-Emitter Saturation Voltage vs. Collector Current (I)

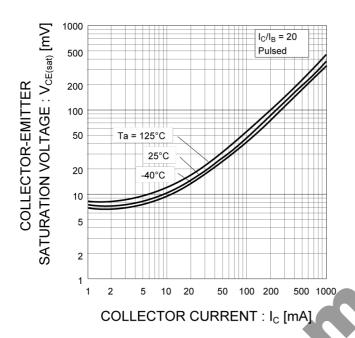
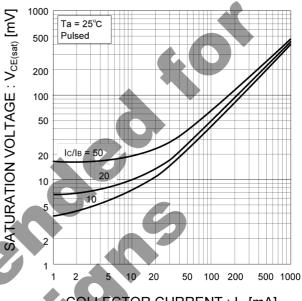


Fig.9 Collector-Emitter Saturation
Voltage vs. Collector Current (II)



COLLECTOR-EMITTER

COLLECTOR CURRENT : Ic [mA]

Fig.10 Base-Emitter Saturation Voltage vs. Collector Current

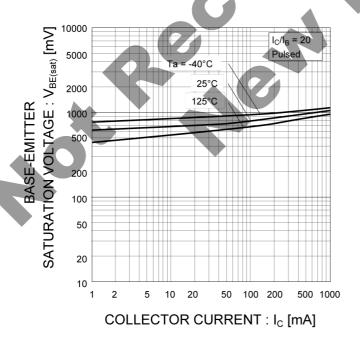
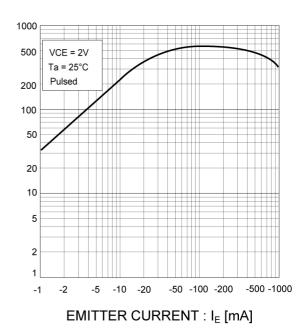


Fig.11 Gain Bandwidth Product vs. Emitter Current



TRANSITION FREQUENCY : fr [MH₇]

● Electrical characteristic curves(Ta=25°C) < For Transistor>

Fig.12 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

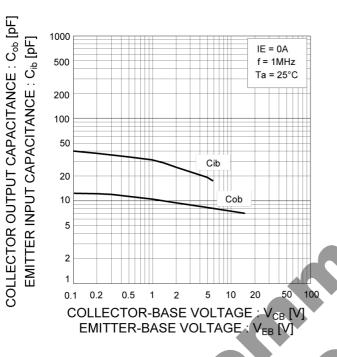
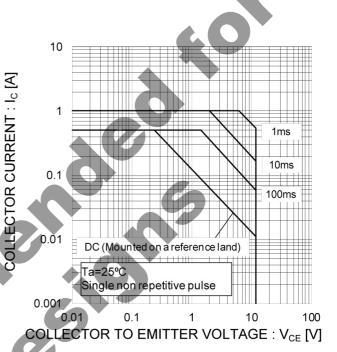
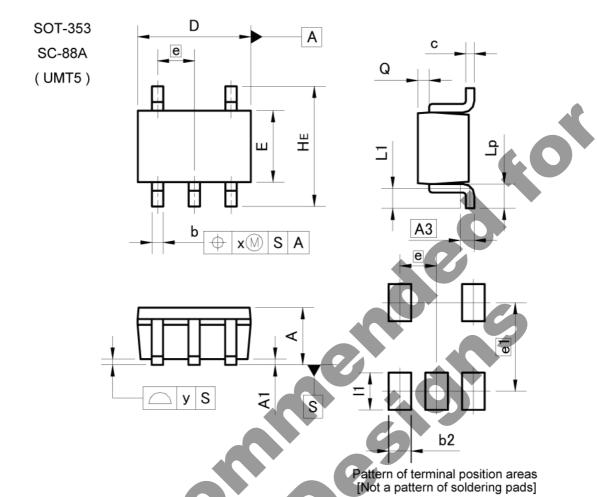


Fig.13 Safe Operating Area



Dimensions



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.65		0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10		0.004
У	 0	0.10	0.77	0.004

DIM	DIM MILIMETERS MAX		INC	HES
DIM			MIN	MAX
b2	=	0.40	-	0.016
e1	1.55		0.0	61
11	-	0.65		0.026

Dimension in mm/inches



Rev.003

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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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